What is Claimed is:

 A circuit pad for reducing discomfort caused by a magnetic stimulation device, comprising:

at least one conductor located peripheral to the magnetic stimulation device, wherein the conductor is adapted to reduce stimulation induced by the magnetic stimulation device.

- The circuit pad of claim 1, further comprising a circuit in communication with the conductor.
- The circuit pad of claim 1, further comprising reducing stimulation by the magnetic stimulation device at a predetermined location.
- The circuit pad of claim 3, wherein the predetermined location is determined relative to a treatment area.
- The circuit pad of claim 4, wherein the treatment area is a portion of a brain and wherein the predetermined location is a cutaneous-proximate area relative to the treatment area.
- 6. The circuit pad of claim 1, further comprising a connector in communication with the conductor, wherein the connector provides an interface with the magnetic stimulation device.
- The circuit pad of claim 1, further comprising a disposal mechanism that renders the circuit pad inoperable.
- 8. The circuit pad of claim 7, wherein the disposal mechanism acts automatically upon removal from a patient.
- The circuit pad of claim 7, wherein the disposal mechanism is activated by a user of the circuit pad.
- 10. The circuit pad of claim 7, wherein the disposal mechanism changes the physical and electrical properties of the conductor.

- The circuit pad of claim 7, wherein the disposal mechanism disconnects communication between the conductor and the circuit.
- The circuit pad of claim 7, wherein the disposal mechanism is activated after a predetermined number of uses.
- 13. The circuit pad of claim 7, wherein the disposal mechanism permits a certain patient to use the circuit pad for a predetermined period.
- The circuit pad of claim 13, wherein the predetermined period is a function of a number of uses.
- The circuit pad of claim 13, wherein the predetermined period is a function of a number of a duration of time.
- 16. The circuit pad of claim 7, wherein the disposal mechanism destroys the circuit pad upon removal from the patient.
- 17. The circuit pad of claim 7, wherein the disposal mechanism is constructed of materials that cannot be sanitized.
- 18. The circuit pad of claim 7, wherein the circuit pad is adapted to become inoperable when contacted with cleaning materials.
- 19. The circuit pad of claim 7, wherein the circuit pad is constructed of materials that disintegrate when in contact with cleaning solutions.
- 20. The circuit pad of claim 1, wherein the circuit pad is adapted to be attached to the patient.
- The circuit pad of claim 1, wherein the circuit pad is adapted to be attached to the magnetic stimulation device.

- 22. The circuit pad of claim 1, wherein the circuit pad comprises an adhesive.
- 23. The circuit pad of claim 1, wherein the conductor is a flat metallic device.
- The circuit pad of claim 23, wherein the conductor is located between two surfaces of the circuit pad.
- 25. The circuit pad of claim 1, wherein the conductor has an area of in the range of 1 centimeter² to 40 centimeter².
- 26. The circuit pad of claim 1, wherein the reducing of the stimulation occurs by reducing magnetic flux density created by the magnetic stimulation device.
- 27. The circuit pad of claim 1, wherein the reducing of the stimulation occurs by superimposing a magnetic field created by the conductors on the circuit pad and a magnetic field created by the magnetic stimulation device:
- 28. The circuit pad of claim 1, wherein the conductor is provided electrical energy substantially simultaneously with electrical energy provided to the magnetic stimulation device.
- 29. The circuit pad of claim 28, wherein the electrical energy provided to the conductor and the electrical energy provided to the magnetic stimulation device are of opposite polarity.
- 30. The circuit pad of claim 28, wherein the electrical energy provided to the conductor is a current that is derived from a voltage provided to the magnetic stimulation device.
- 31. The circuit pad of claim 1, wherein the circuit pad is adapted to receive a conductive gel that facilitates communication between the circuit pad and a treatment area.
- 32. The circuit pad of claim 31, wherein the conductive gel is received by an absorbent portion of the circuit pad.

- 33. The circuit pad of claim 32, wherein the absorbent portion of the circuit pad comprises a sponge material.
- 34. The circuit pad of claim 31, wherein the conductive gel is located within a plastic material on the circuit pad.
- 35. The circuit pad of claim 1, wherein the conductor is placed substantially orthogonal to an electric field vector created by the magnetic stimulation device.
 - 36. The circuit pad of claim 1, wherein the conductor has rounded edges.
 - 37. The circuit pad of claim 1, wherein the conductor has a high aspect ratio.
- 38. The circuit pad of claim 1, wherein a relatively longer dimension of the conductor is placed along a similar direction as an electric field vector induced by the magnetic stimulation device.
 - 39. The circuit pad of claim 1, wherein the conductor is arc-shaped.
- 40. The circuit pad of claim 1, further comprising insulating material for preventing undesired electrical conduction with the circuit pad.
- 41. The circuit pad of claim 1, wherein the circuit pad is constructed of a flexible material.
- 42. The circuit pad of claim 1, wherein the circuit pad is constructed, at least in part, by materials including at least one of the following: plastic, mylar, polyester, Kapton™.
- 43. The circuit pad of claim 1, wherein the magnetic stimulation device comprises a magnetic core that saturates at 0.5 Tesla or greater.
- 44. A method for treating a patient using transcutaneous magnetic stimulation, comprising:

directing a magnetic field created by a magnetic stimulation device to a treatment area on the patient;

applying a flexible circuit pad, wherein the flexible circuit pad comprises at least one conductor adapted to reduce stimulation induced by the magnetic stimulation device; and

treating the patient with the magnetic field.

- 45. The method of claim 44, wherein the magnetic stimulation device comprises a magnetic core that saturates at 0.5 Tesla or greater.
- 46. The method of claim 44, further comprising applying the flexible circuit pad to the treatment area.
- 47. The method of claim 44, further comprising applying the flexible circuit pad to the magnetic stimulation device.
- 48. The method of claim 44, wherein the magnetic stimulation device comprises a magnetic core with a non-toroidal geometry.
- 49. The method of claim 44, wherein the conductor reduces stimulation of a cutaneous-proximate area on the patient.
- 50. The method of claim 44, further comprising locating the magnetic stimulation device to the treatment area on the patient.
- 51. The method of claim 44, further comprising applying the flexible circuit pad to the patient.
- 52. The method of claim 44, further comprising applying a conductive gel material between the flexible circuit pad and the patient.
- 53. The method of claim 44, further comprising insulating the flexible circuit pad from undesired electrical conduction.

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- 54. The method of claim 44, further comprising activating a disposal mechanism that renders the flexible circuit pad inoperable.
- 55. The method of claim 54, wherein the activating of the disposal mechanism occurs after the patient is treated with the magnetic field.
- 56. The method of claim 54, further wherein the activating of the disposal mechanism occurs automatically upon removal from a patient.
- 57. The method of claim 54, wherein activating of the disposal mechanism is conducted by a user of the flexible circuit pad.
- 58. The method of claim 54, wherein the activating of the disposal mechanism comprises changing the physical and electrical properties of the conductor.
- 59. The method of claim 54, wherein the activating of the disposal mechanism comprises disconnecting communication with the flexible circuit pad.
- 60. The method of claim 54, wherein the activating of the disposal mechanism occurs after a predetermined number of uses.
- The method of claim 44, further comprising adapting the flexible circuit pad to be attached to the patient.
- 62. The method of claim 44, further comprising adapting the flexible circuit pad to be attached to the magnetic stimulation device.
- 63. The method of claim 44, further comprising applying an adhesive to the flexible circuit pad.
- 64. The method of claim 44, further comprising providing a conductive gel that facilitates communication with the flexible circuit pad.

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- 65. The method of claim 44, further comprising injecting a conductive gel that facilitates communication with the flexible circuit pad.
- 66. The method of claim 44, wherein the circuit pad is constructed, at least in part, by materials including at least one of the following: plastic, mylar, polyester, Kapton™.
- 67. A circuit pad for reducing discomfort caused by a magnetic stimulation device, comprising:

a ferrite material located peripheral to the magnetic stimulation device, wherein the ferrite material is adapted to reduce stimulation induced by the magnetic stimulation device.

- 68. The circuit pad of claim 67, further comprising a circuit in communication with the ferrite material.
- 69. The circuit pad of claim 67, wherein the ferrite material is located between two surfaces of the circuit pad.